

NPN 100mA 50V Digital Transistors (Bias Resistor Built-in Transistors)

Parameter	Value
V <sub>CEO</sub>	50V
I <sub>C</sub>	100mA
R <sub>1</sub>	4.7kΩ

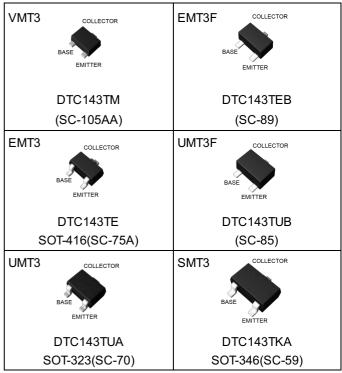
#### Features

- 1) Built-In Biasing Resistor
- Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) The bias resistors consist of thin-film resistors with complete isolation to allow negative biasing of the input. They also have the advantage of completely eliminating parasitic effects.
- 4) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 5) Complementary PNP Types: DTA143T series
- 6) Complex transistors: EMH3/ UMH3N/ IMH3A/ EMG3/ UMG3N/ FMG3A (PNP type)
- 7) Lead Free/RoHS Compliant.

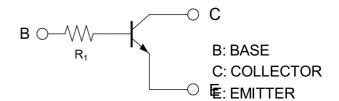
#### Application

Switching circuit, Inverter circuit, Interface circuit, Driver circuit

#### Outline



#### •Inner circuit



#### Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTC143TM	VMT3	1212	T2L	180	8	8000	03
DTC143TEB	EMT3F	1616	TL	180	8	3000	03
DTC143TE	EMT3	1616	TL	180	8	3000	03
DTC143TUB	UMT3F	2021	TL	180	8	3000	03
DTC143TUA	UMT3	2021	T106	180	8	3000	03
DTC143TKA	SMT3	2928	T146	180	8	3000	03

# ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

Pa	arameter	Symbol	Values	Unit
Collector-base voltage		$V_{CBO}$	50	V
Collector-emitter voltage			50	V
Emitter-base voltage			5	V
Collector current		I <sub>C</sub>	100	mA
	DTC143TM		150	
	DTC143TEB		150	mW
Davie a discipation	DTC143TE	P <sub>D</sub> *1	150	
Power dissipation	DTC143TUB	P <sub>D</sub> .	200	
	DTC143TUA		200	
	DTC143TKA		200	
Junction temperature		T <sub>j</sub>	150	°C
Range of storage temperate	ture	T <sub>stg</sub>	-55 to +150	°C

# ● Electrical characteristics (T<sub>a</sub> = 25°C)

Davanatas	Symbol Conditions -		Values			1.1
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Collector-base breakdown voltage	BV <sub>CBO</sub>	I <sub>C</sub> = 50μA	50	-	-	V
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>C</sub> = 1mA	50	-	-	V
Emitter-base breakdown voltage	BV <sub>EBO</sub>	I <sub>E</sub> = 50μA	5	-	-	V
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = 50V	-	-	0.5	μA
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = 4V	-	-	0.5	μA
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_{C} / I_{B} = 5 \text{mA} / 0.25 \text{mA}$	-	-	0.15	V
DC current gain	h <sub>FE</sub>	V <sub>CE</sub> = 5V, I <sub>C</sub> = 1mA	100	250	600	-
Input resistance	R <sub>1</sub>	-	3.5	4.7	5.9	kΩ
Transition frequency	f <sub>T</sub> *2	V <sub>CE</sub> = 10V, I <sub>E</sub> = -5mA, f = 100MHz	-	250	-	MHz

<sup>\*1</sup> Each terminal mounted on a reference footprint

<sup>\*2</sup> Characteristics of built-in transistor

#### ● Electrical characteristic curves(Ta=25°C)

Fig.1 Grounded emitter propagation characteristics

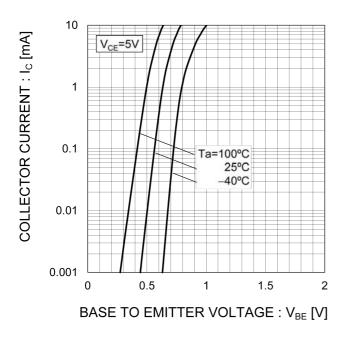


Fig.2 Grounded emitter output characteristics

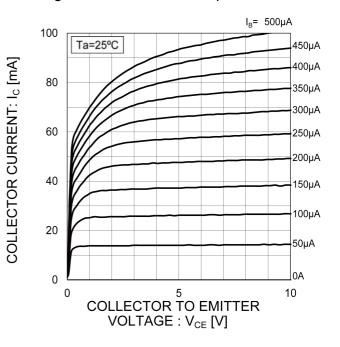


Fig.3 DC Current gain vs. Collector Current

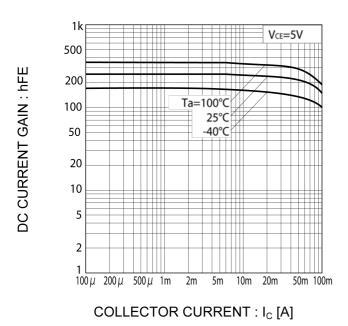
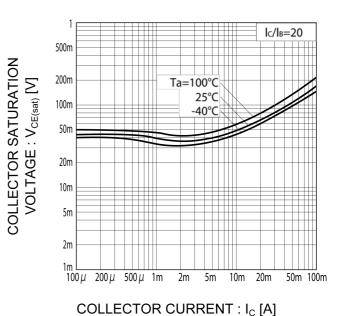
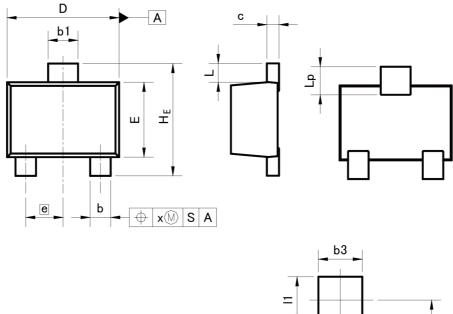


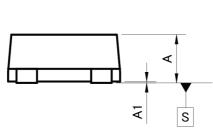
Fig.4 Collector-emitter saturation voltage vs.

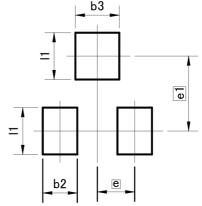
Collector Current











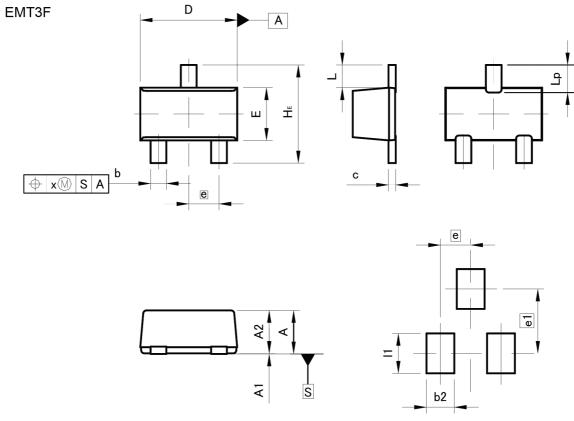
Pattern of terminal position areas [Not a recommended pattern of soldering pads]

DIM -	MILIM	ETERS	INC	HES
DIM [	MIN	MAX	MIN	MAX
Α	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
b1	0.27	0.37	0.011	0.015
С	0.08	0.18	0.003	0.007
D	1.10	1.30	0.043	0.051
E	0.70	0.90	0.028	0.035
е	0.4	40	0.0	02
HE	1.10	1.30	0.043	0.051
L	0.10	0.30	0.004	0.012
Lp	0.20	0.40	0.008	0.016
x	=	0.10	=	0.004

DIM	MILIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
b2	-	0.37		0.015
b3	-	0.47	<del></del>	0.019
e1	0.	80	0.0	031
11	-	0.50	-	0.020

Dimension in mm/inches





Pattern of terminal position areas [Not a recommended pattern of soldering pads]

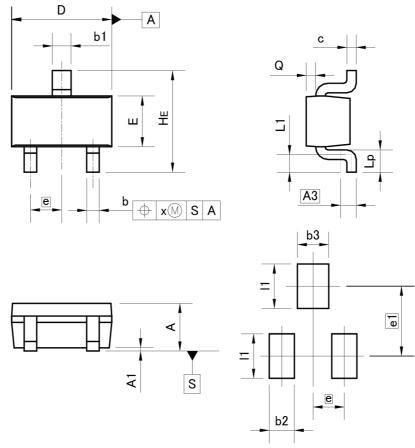
DIM	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
Α	0.65	0.85	0.026	0.033
A1	0.00	0.10	0.000	0.004
A2	0.60	0.80	0.024	0.031
b	0.21	0.36	0.008	0.014
С	0.08	0.18	0.003	0.007
D	1.50	1.70	0.059	0.067
E	0.76	0.96	0.030	0.038
е	0.9	50	0.0	20
HE	1.50	1.70	0.059	0.067
L	0.3	37	0.0	15
Lp	0.35	0.55	0.014	0.022
х	=	0.10	<u> </u>	0.004

DIM	MILIM	MILIMETERS		HES
DIM	MIN	MAX	MIN	MAX
b2	_	0.46	<u>—</u>	0.018
e1	<b>5</b> .	1.05	<i>π</i> .	0.041
11	-	0.65	<del></del> :	0.026

Dimension in mm/inches



EMT3



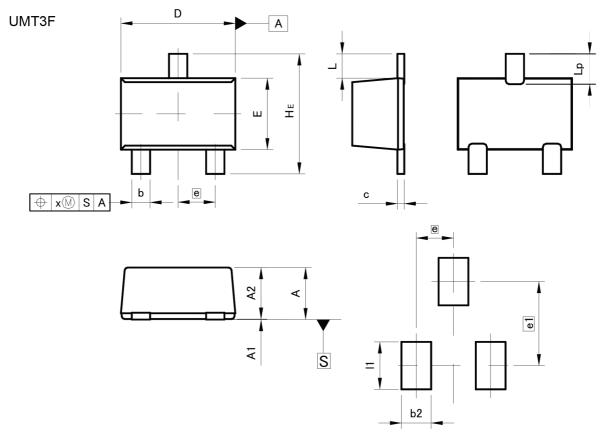
Pattern of terminal position areas [Not a recommended pattern of soldering pads]

DIM	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
Α	0.60	0.80	0.024	0.031
A1	0.00	0.10	0.000	0.004
A3	0.	25	0.0	10
b	0.15	0.30	0.006	0.012
b1	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.50	1.70	0.059	0.067
E	0.70	0.90	0.028	0.035
е	0.	50	0.0	20
HE	1.40	1.80	0.055	0.071
L1	0.10	<del></del> :	0.004	
Lp	0.15	<del>55</del> 3:	0.006	TT.
Q	0.05	0.25	0.002	0.010
x	<b>—</b> 1	0.10	_	0.004

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
b2	77.L	0.40	-54	0.016
b3		0.50	-	0.020
e1	1.	10		043
11	<del>12</del> 5	0.70	-	0.028

Dimension in mm/inches





Pattern of terminal position areas [Not a recommended pattern of soldering pads]

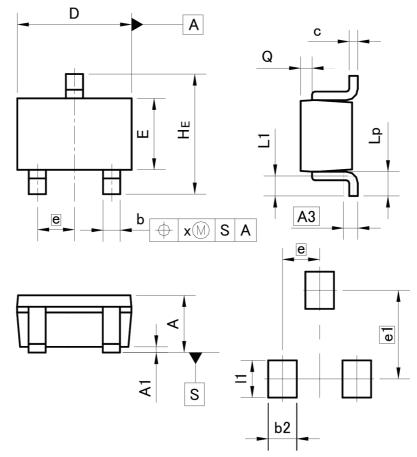
DIM -	MILIM	ETERS	INCHES	
DIN	MIN	MAX	MIN	MAX
Α	0.85	1.05	0.033	0.041
A1	0.00	0.10	0.000	0.004
A2	0.80	1.00	0.031	0.039
b	0.27	0.42	0.011	0.017
С	0.08	0.18	0.003	0.007
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.0	65	0.0	26
HE	2.00	2.20	0.079	0.087
L	0.4	43	0.0	17
Lp	0.43	0.63	0.017	0.025
х	=	0.10	27	0.004

DIM -	MILIM	MILIMETERS		HES
DIM	MIN	MAX	MIN	MAX
b2	_	0.52	<u>—</u>	0.020
e1	1.	1.47		058
11	-	0.83		0.033

Dimension in mm/inches



UMT3



Pattern of terminal position areas [Not a recommended pattern of soldering pads]

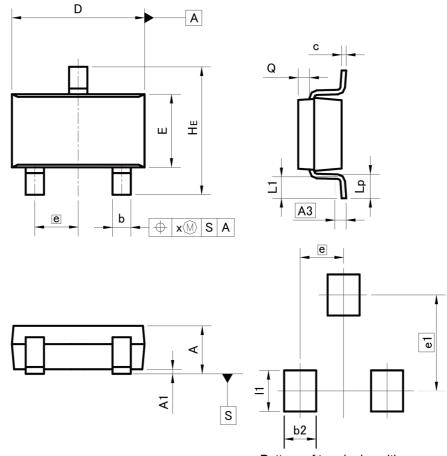
DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
Α	0.80	1.00	0.031	0.039
A1	0.00	0.10	0.000	0.004
A3	0.25		0.010	
b	0.15	0.30	0.006	0.012
С	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.65		0.026	
HE	2.00	2.20	0.079	0.087
L1	0.20	0.50	0.008	0.020
Lp	0.25	0.55	0.010	0.022
Q	0.10	0.30	0.004	0.012
х	=	0.10	=	0.004

DIM	MILIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
b2		0.50		0.020
e1	1.55		0.061	
11	_	0.65	-	0.026

Dimension in mm/inches



SMT3



Pattern of terminal position areas [Not a recommended pattern of soldering pads]

DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
Α	1.00	1.30	0.039	0.051
A1	0.00	0.10	0.000	0.004
A3	0.25		0.010	
b	0.35	0.50	0.014	0.020
С	0.09	0.25	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.95		0.037	
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.20	0.30	0.008	0.012
x	20	0.10	722	0.004
у	<u> </u>	0.10	_	0.004
DIM	MILIMETERS		INCHES	
	MIN	MAX	MIN	MAX
b2	=	0.60	-	0.024

Dimension in mm/inches

e1



0.035

0.083

0.90

2.10

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